506360286 11/18/2020

## PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT6407041

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

#### **CONVEYING PARTY DATA**

Name	Execution Date
HSI-KAI LO	11/04/2020
MING-HUNG LAI	11/04/2020

### **RECEIVING PARTY DATA**

Name:	WINBOND ELECTRONICS CORP.
Street Address:	NO. 8 KEYA 1ST RD., DAYA DISTRICT, CENTRAL TAIWAN SCIENCE PARK,
City:	TAICHUNG CITY
State/Country:	TAIWAN

### **PROPERTY NUMBERS Total: 1**

Property Type	Number
Application Number:	17099129

### **CORRESPONDENCE DATA**

**Fax Number:** (703)621-7155

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

**Phone:** 7036217140

**Email:** mailroom@mg-ip.com

Correspondent Name: MUNCY, GEISSLER, OLDS & LOWE, PC

Address Line 1: 4000 LEGATO RD., SUITE 310
Address Line 4: FAIRFAX, VIRGINIA 22033

ATTORNEY DOCKET NUMBER:	0941/3864PUS1
NAME OF SUBMITTER:	JOE MCKINNEY MUNCY
SIGNATURE:	/Joe McKinney Muncy/
DATE SIGNED:	11/18/2020

**Total Attachments: 1** 

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PATENT 506360286 REEL: 054402 FRAME: 0739

# ASSIGNMENT

WHEREAS, Hsi-Kai LO and Ming-Hung LAI
hereafter referred to as ASSIGNOR, has/have invented certain new and useful improvements
as described and set forth in the below identified application for United States Letters Patent:
Title: SEMICONDUCTOR DEVICE AND METHOD FOR FORMING THE SAME
Filed: November 16, 2020 Serial No. 17/099,129
Executed on:
WHEREAS, Winbond Electronics Corp. of No: 8 Keya 1st Rd.,
Daya District, Central Taiwan Science Park, Taichung City,
Taiwan, R.O.C. hereinafter referred to as ASSIGNEE, is desirous of acquiring ASSIGNOR'S interest in the said invention and application and in any U.S. Letters Patent
which may be granted on the same;
and the same of th
NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN: Be it known that, for
good and valuable consideration, receipt of which is hereby acknowledged by Assignor,
Assignor has/have sold, assigned and transferred, and by these presents does/do sell, assign
and transfer unto the said Assignee, and Assignee's successors and assigns, all his/her/their rights, title and interest in and to the said invention and application and all future
improvements thereon, and in and to any Letters Patent which may hereafter be granted on the
same in the United States, the said interest to be held and enjoyed by said Assignee as fully
and exclusively as it would have been held and enjoyed by said Assignor had this Assignment
and transfer not been made, to the full end and term of any Letters Patent which may be
granted thereon, or of any division, renewal, continuation in whole or in part, substitution, conversion, reissue, prolongation or extension thereof.
conversion, reassie, projongation of extension mercor.
Assignor further agrees/agree that he/she/they will, without charge to said
Assignee, but at Assignee's expense, cooperate with Assignee in the prosecution of said
application and/or applications, execute, verify, acknowledge and deliver all such further
papers, including applications for Letters Patent and for the reissue thereof, and instruments of assignment and transfer thereof, and will perform such other acts as Assignee lawfully may
request, to obtain or maintain Letters Patent for said invention and improvement, and to vest
title thereto in said Assignee, or Assignee's successors and assigns.
DI MERCHA COLEY MINER TOR 1
IN TESTIMONY WHEREOF, Assignor has/have signed his/her/their name(s) on the date(s) indicated.
date(5) Indicated.
HSi Kai Lo November 4, 2020
Hsi-Kai LO Date
Ming-Hung LM November 4, 2020  Ming-Hung LAI Date
Ming-Hyng LAI () Date
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**RECORDED: 11/18/2020** 

PATENT REEL: 054402 FRAME: 0740